

**PRODUCT / PROCESS CHANGE INFORMATION**

**1. PCI basic data**

<b>1.1 Company</b>		STMicroelectronics International N.V
<b>1.2 PCI No.</b>	CRP/19/11772	
<b>1.3 Title of PCI</b>	Inner Box Change for Automation Packing	
<b>1.4 Product Category</b>	To refer to product list	
<b>1.5 Issue date</b>	2019-10-30	

**2. PCI Team**

<b>2.1 Contact supplier</b>	
<b>2.1.1 Name</b>	FRANK SCHIFANO
<b>2.1.2 Phone</b>	+1 5148333778
<b>2.1.3 Email</b>	frank.schifano@st.com
<b>2.2 Change responsibility</b>	
<b>2.2.1 Process Owner</b>	Chiara ZACCHERINI
<b>2.1.2 Corporate Quality Manager</b>	Gerard PETIT

**3. Change**

<b>3.1 Category</b>	<b>3.2 Type of change</b>	<b>3.3 Manufacturing Location</b>
Materials	Any indirect material modifications for shipping products in dimensions, material, composition, orientation...	BEMT Plant / ST Shenzhen

**4. Description of change**

	<b>Old</b>	<b>New</b>
<b>4.1 Description</b>	Current inner BOX - PN / 3CP71972 Open Position : Side	New inner BOX - PN / 3CP90018 Open Position : Top
<b>4.2 Anticipated Impact on form,fit, function, quality, reliability or processability?</b>	Form: no change Fit: no change (Inner Box opening from Side direction to Top direction) Function: no change Reliability : no change Processability : no change	

**5. Reason / motivation for change**

<b>5.1 Motivation</b>	- To deploy Automation on Packing Line in ST Shenzhen - Current inner box 3CP71972 can only be open in side direction, this can't be handled by Automation Handler - To introduce new inner box design 3CP90018 which could be open on top direction to accommodate by the machine
<b>5.2 Customer Benefit</b>	MANUFACTURING FLEXIBILITY

**6. Marking of parts / traceability of change**

<b>6.1 Description</b>	To refer to product list
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**7. Timing / schedule**

<b>7.1 Date of qualification results</b>	2019-11-18
<b>7.2 Intended start of delivery</b>	2019-11-25
<b>7.3 Qualification sample available?</b>	Upon Request

**8. Qualification / Validation**

<b>8.1 Description</b>			
<b>8.2 Qualification report and qualification results</b>	In progress	<b>Issue Date</b>	

**9. Attachments (additional documentations)**

11772 Public product.pdf  
11772 PCI\_Review W38 with Shenzhen Team\_W42\_Final.docx

**10. Affected parts**

10. 1 Current		10.2 New (if applicable)
10.1.1 Customer Part No	10.1.2 Supplier Part No	10.1.2 Supplier Part No
	M95128-DRMN8TP/K	
	STM8S003F3P6TR	

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